



US 20170125725A1

(19) **United States**(12) **Patent Application Publication**
PAEK et al.(10) **Pub. No.: US 2017/0125725 A1**(43) **Pub. Date: May 4, 2017**(54) **ORGANIC LIGHT EMITTING DISPLAY
DEVICE AND METHOD OF FABRICATING
THE SAME***H01L 51/56* (2006.01)*H01L 51/50* (2006.01)*H01L 27/32* (2006.01)(71) Applicant: **LG Display Co., Ltd.**, Seoul (KR)(52) **U.S. Cl.**CPC *H01L 51/5212* (2013.01); *H01L 51/504*
(2013.01); *H01L 51/5228* (2013.01); *H01L*
27/3246 (2013.01); *H01L 51/56* (2013.01);
H01L 51/0021 (2013.01); *H01L 51/0003*
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(57)

ABSTRACT

An organic light emitting display device includes a substrate including a pixel region, and a first electrode over the substrate and in the pixel region. An auxiliary electrode is disposed over the substrate, and is spaced apart from the first electrode and disposed in between the pixel region and another pixel region. A second electrode is placed over the first electrode and the auxiliary electrode, and an organic layer is disposed between each of the first electrode and the second electrode, and the second electrode and the auxiliary electrode. A conductive member is placed between the auxiliary electrode and the second electrode and electrically connects the second electrode to the auxiliary electrode.

(21) Appl. No.: **15/334,997**(22) Filed: **Oct. 26, 2016**(30) **Foreign Application Priority Data**

Nov. 3, 2015 (KR) 10-2015-0154133

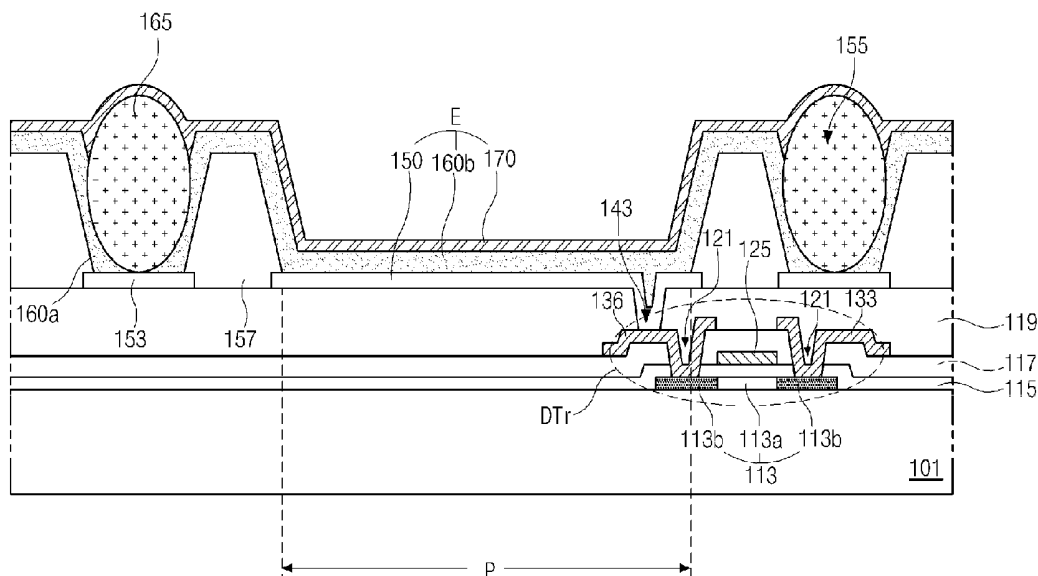
Publication Classification(51) **Int. Cl.***H01L 51/52* (2006.01)*H01L 51/00* (2006.01)

FIG. 1
Related Art

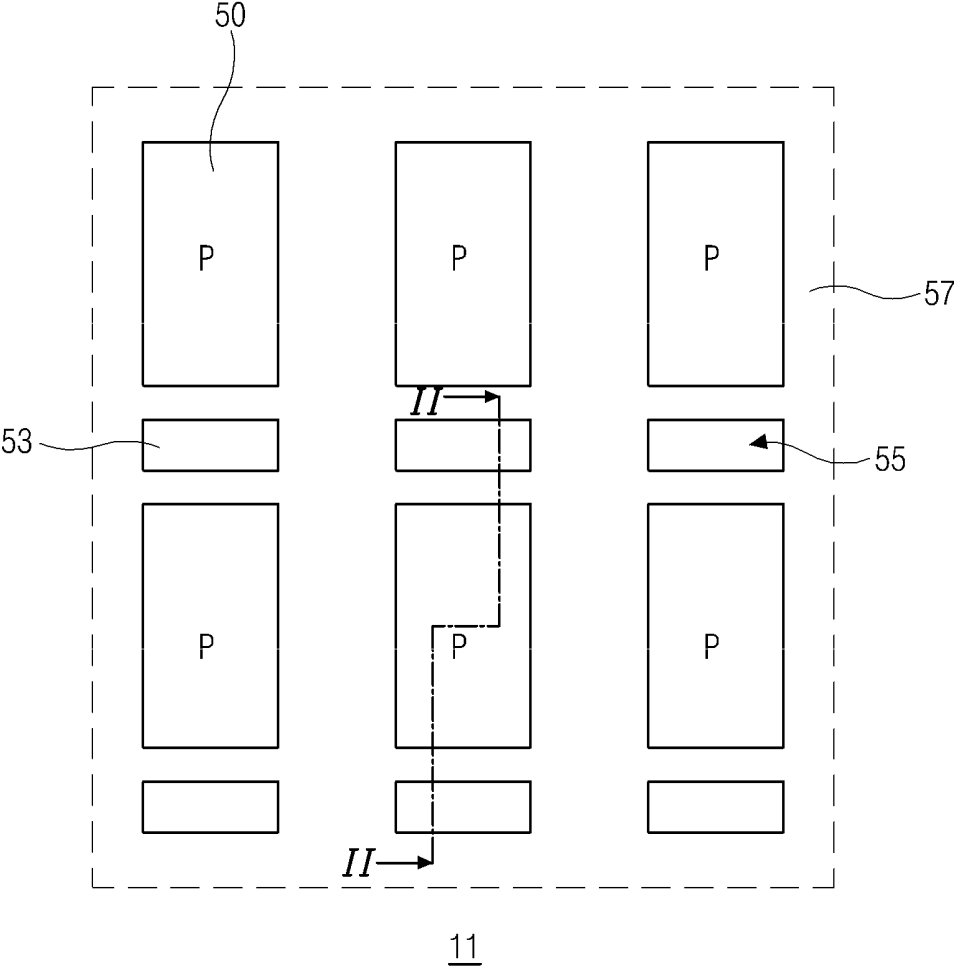


FIG. 2
Related Art

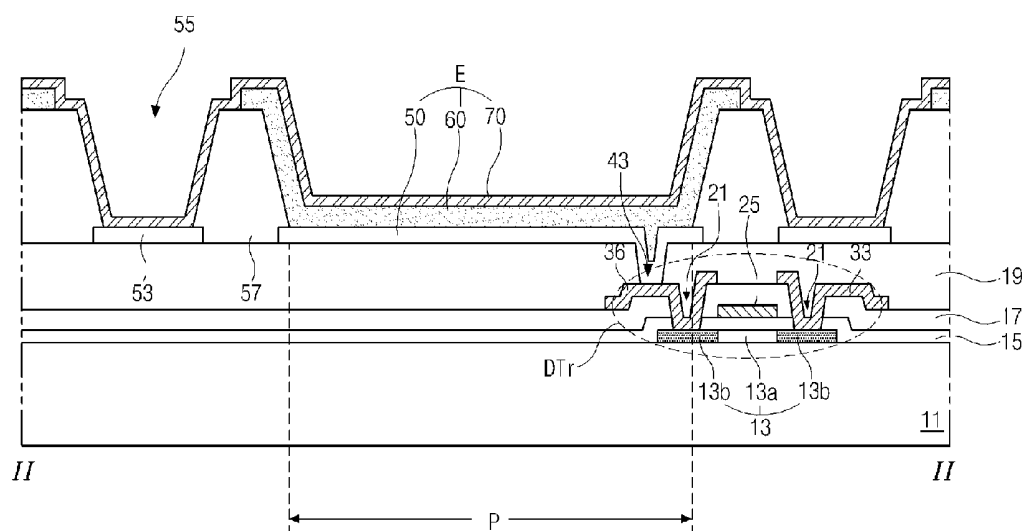


FIG. 3

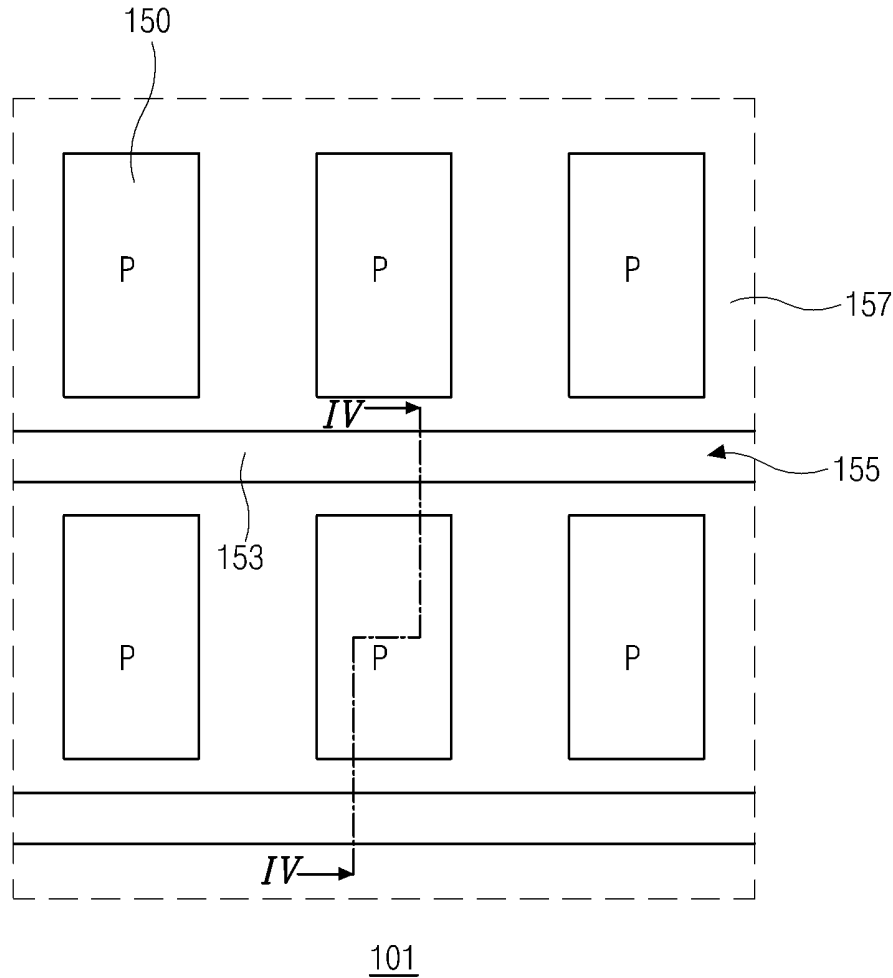


FIG. 4

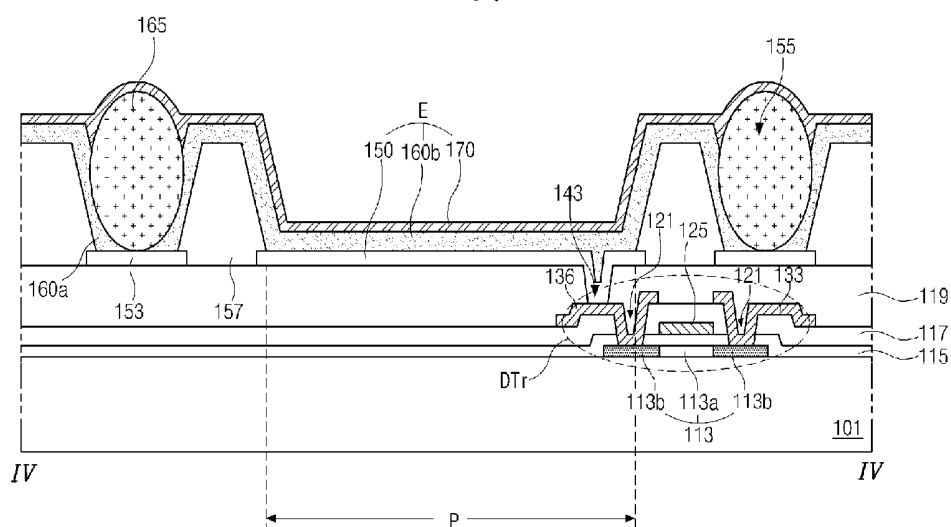


FIG. 5A

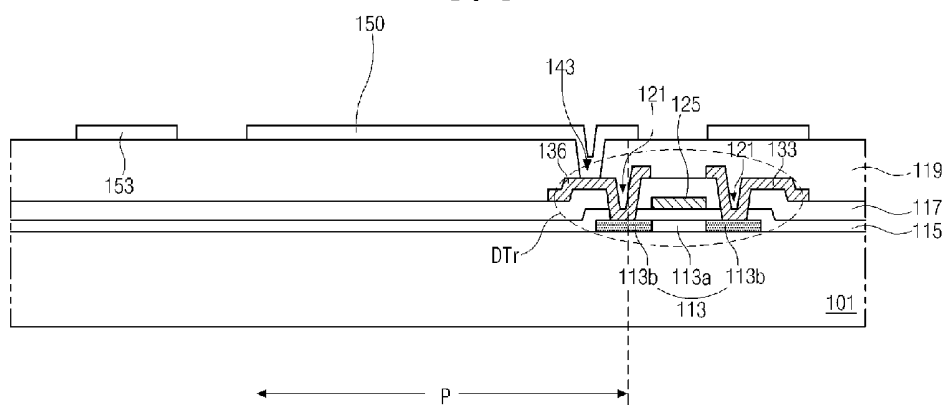


FIG. 5B

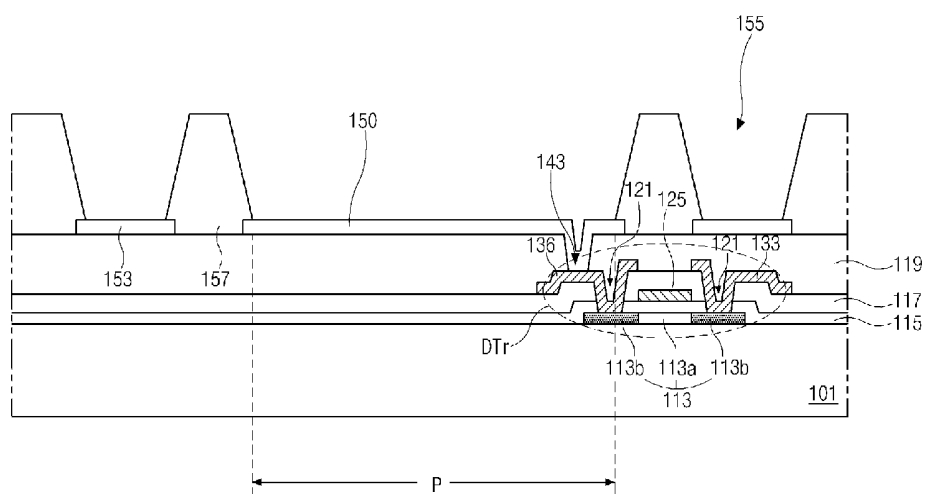


FIG. 5C

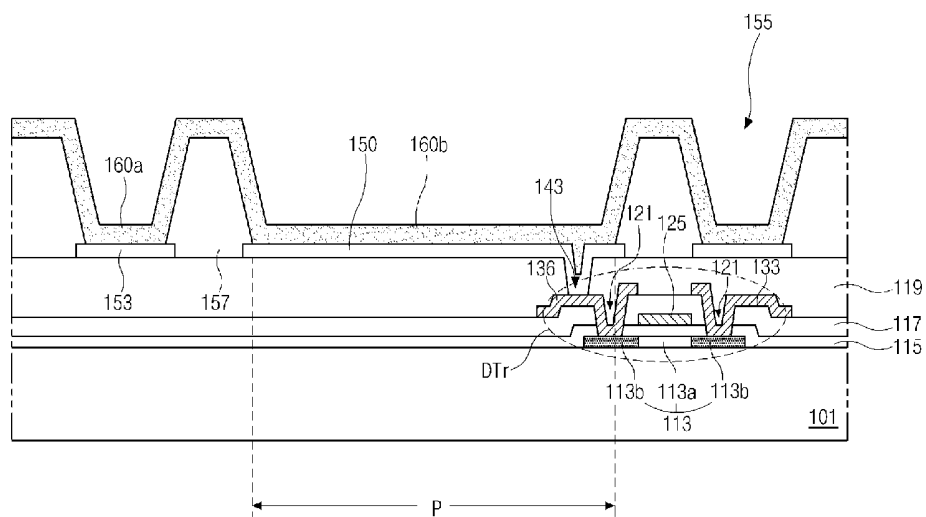


FIG. 5D

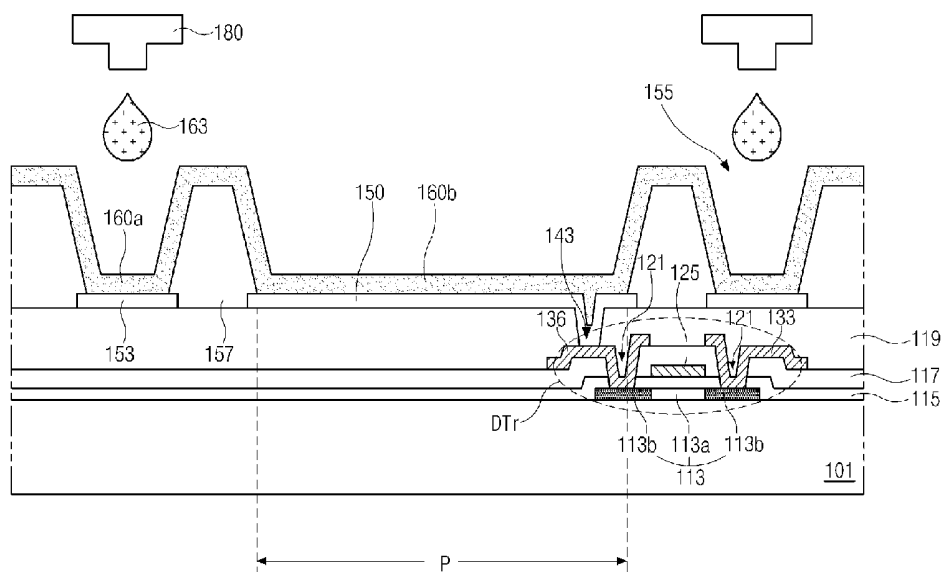


FIG. 5E

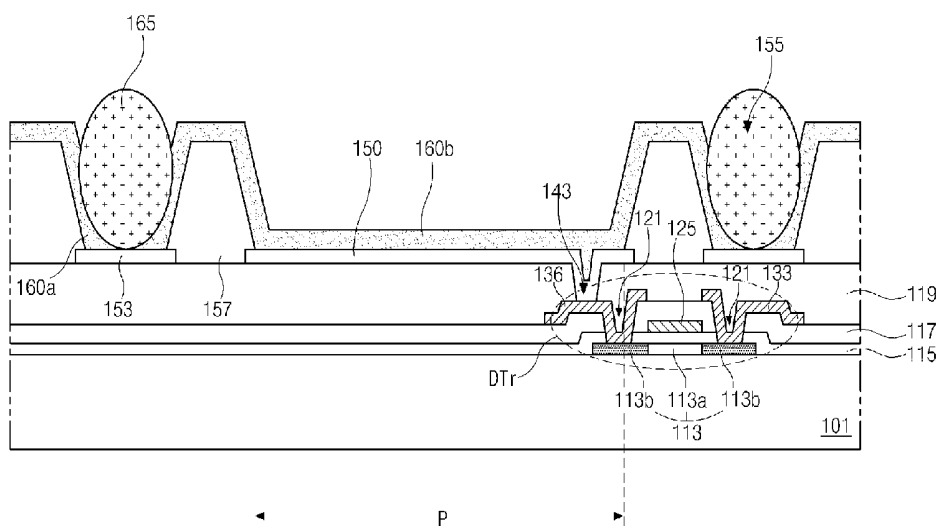
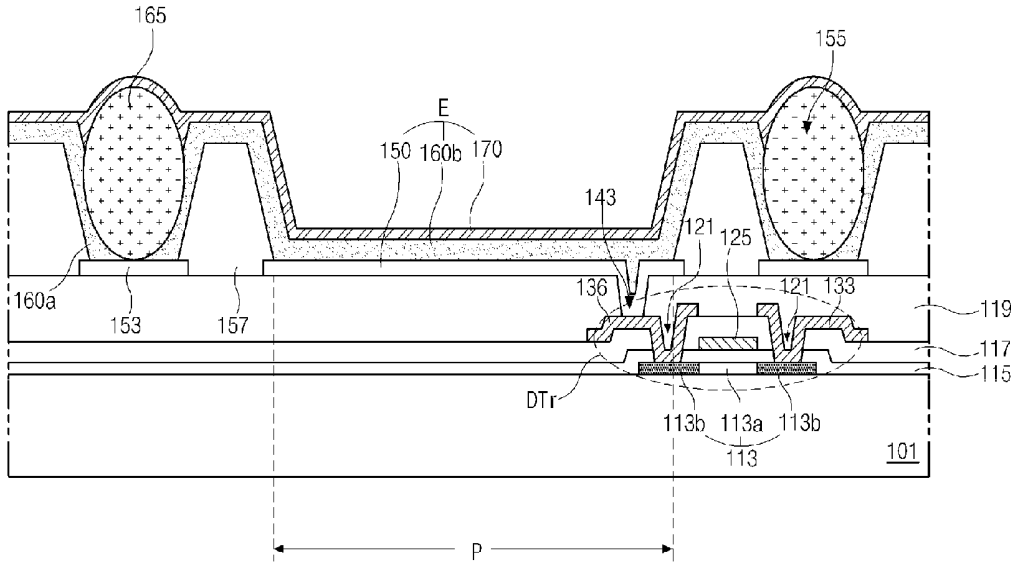


FIG. 5F



ORGANIC LIGHT EMITTING DISPLAY DEVICE AND METHOD OF FABRICATING THE SAME

CROSS-REFERENCE TO RELATED APPLICATIONS

[0001] The present application claims the benefit of Republic of Korea Patent Application No. 10-2015-0154133, filed in the Republic of Korea on Nov. 3, 2015, which is hereby incorporated by reference in its entirety.

BACKGROUND

[0002] 1. Field

[0003] The present disclosure relates to an organic light emitting display (OLED) device, and more particularly, to an OLED being capable of preventing a brightness non-uniformity problem.

[0004] 2. Discussion of Related Art

[0005] Recently, flat panel display devices, such as a plasma display panel (PDP), a liquid crystal display (LCD) device, and an OLED device, are widely researched and used.

[0006] Among these flat panel display devices, since the OLED device as a self-emission type display device does not require a backlight unit, the OLED device may have advantages of light weight and thin profile.

[0007] In addition, the OLED device has excellent characteristics of a viewing angle, a contrast ratio, power consumption, a response time, production costs, production yield, and so on.

[0008] The OLED device may include a switching thin film transistor (TFT), which is connected to gate and data lines, a driving TFT, which is connected to the switching TFT, and an organic emitting diode. The organic emitting diode is connected to the driving TFT and includes a first electrode, an organic emitting layer and a second electrode.

[0009] The first electrode may serve as an anode and may include a transparent conductive material having a relatively high work function. The second electrode may serve as a cathode and may include a metallic material having a relatively low work function. The metallic material may have an opaque property.

[0010] In a top emission type OLED device, the light from the organic emitting layer passes through the second electrode that is partially opaque. Accordingly, a thickness of the second electrode should be controlled such that the second electrode has a good light-transmissive property.

[0011] However, when the thickness of the second electrode is lowered, the resistance of the second electrode is increased such that a voltage drop problem in the second electrode is generated. Namely, a brightness non-uniformity problem in the OLED device is generated.

[0012] Particularly, the above brightness non-uniformity problem is serious in a large-size OLED device.

[0013] To prevent the above brightness non-uniformity problem, an auxiliary line, which is connected to the second electrode, may be formed to reduce the resistance of the second electrode.

[0014] FIG. 1 is a schematic plane view of the related art OLED device, and FIG. 2 is a schematic cross-sectional view taken along the line II-II in FIG. 1.

[0015] Referring to FIG. 1, the related art OLED device includes a substrate 11, which includes a plurality of pixel

regions P, a first electrode 50 disposed on or over the substrate 11 and in each pixel region P, an auxiliary electrode 53 disposed at a boundary of the pixel region P and a bank 57 disposed at the boundary of the pixel region P. The auxiliary electrode 53 is spaced apart from the first electrode 50. The bank 57 covers the auxiliary electrode 53 and edges of the first electrode 50 and includes an auxiliary contact hole 55 exposing a portion of the auxiliary electrode 53.

[0016] The auxiliary electrode 53 and the auxiliary contact hole 55 have substantially the same width as the first electrode 50 and are separately arranged at each pixel region P.

[0017] Referring to FIG. 2, a semiconductor layer 13 including a first region 13a and second regions 13b at both sides of the first region 13a is formed on the substrate 11. The first region 13a is formed of intrinsic poly-silicon, and the second region 13b is formed of impurity-doped poly-silicon.

[0018] A gate insulating layer 15 is formed on the semiconductor layer 13, and a gate electrode 25 corresponding to the first region 13a of the semiconductor layer 13 is formed on the gate insulating layer 15. An interlayer insulating layer 17 is formed on the gate electrode 25.

[0019] In this instance, semiconductor contact holes 21 are formed through the gate insulating layer 15 and the interlayer insulating layer 17 to expose the second regions 13b of the semiconductor layer 13.

[0020] A source electrode 33 and a drain electrode 36, which are spaced apart from each other, are formed on the interlayer insulating layer 17. The source and drain electrodes 33 and 36 are electrically connected to the second regions 13b of the semiconductor layer 13 through the semiconductor contact holes 21, respectively.

[0021] The semiconductor layer 13, the gate electrode 25, the source electrode 33 and the drain electrode 36 constitute a driving TFT DTr.

[0022] A passivation layer 19, which may provide a flat top surface, is formed on or over the driving TFT DTr and over an entire surface of the substrate 11. A drain contact hole 43 exposing the drain electrode 36 of the driving TFT DTr is formed through the passivation layer 19.

[0023] The first electrode 50, which is connected to the drain electrode 36 through the drain contact hole 43, is formed on the passivation layer 19 and in the pixel region P, and the auxiliary electrode 53, which is spaced apart from the first electrode 50, is formed on the passivation layer 19 and at the boundary of the pixel region P.

[0024] The bank 57, which includes the auxiliary contact hole 55 exposing the auxiliary electrode 53 and covers edges of the first electrode 50 and the auxiliary electrode 53, is formed at the boundary of the pixel region P.

[0025] The bank 57 has a lattice shape to surround the pixel region P, and an organic emitting layer 60 is formed on the first electrode 50 in the pixel region P. In addition, a second electrode 70 is formed over an entire surface of the substrate 11 including the bank 57 and the organic emitting layer 60. As a result, the second electrode 70 is electrically connected to auxiliary electrode 53 through the auxiliary contact hole 55.

[0026] The first and second electrodes 50 and 70 and the organic emitting layer 60 therebetween constitute an organic emitting diode E.

[0027] Since the auxiliary electrode 53 is electrically connected to the second electrode 70, the sheet resistance of

the second electrode **70** is lowered. As a result, the brightness non-uniformity problem can be prevented or minimized.

[0028] On the other hand, the organic emitting layer **60** may include a hole injection layer (HIL), a hole transport layer (HTL), an emitting material layer (EML), an electron transport layer (ETL) and an electron injection layer (EIL) sequentially stacked on the first electrode **50**.

[0029] Each of the layers of the organic emitting layer **60** may be formed by a solution process or a deposition process. For example, since some materials for each layer of the organic emitting layer **60** has bad stability for the soluble process, the HIL, the HTL and the EML are formed by the soluble process and the ETL and the EIL are formed by the deposition process.

[0030] In addition, the blue emitting material does not provide the desired property by the soluble process. Accordingly, the blue emitting material pattern may be formed by the deposition process over an entire surface of the substrate **11**. Namely, each of the HIL, the HTL, the red emitting material pattern and the green emitting material pattern is formed in each pixel region **P** by the solution process, while each of the blue emitting material pattern, the ETL and the EIL is formed over an entire surface of the substrate **11** through a deposition process.

SUMMARY

[0031] Accordingly, embodiments are directed to an OLED device and a method of fabricating the same that substantially obviate one or more of the above problems due to limitations and disadvantages of the related art.

[0032] There is provided an OLED device including a second electrode having reduced sheet resistance.

[0033] An object of the claimed subject-matter is to simplify a fabricating process and reduce production cost of an OLED device.

[0034] Additional features and advantages will be set forth in the description which follows, and in part will be apparent from the description, or may be learned by practice. The objectives and other advantages will be realized and attained by the structure particularly pointed out in the written description and claims hereof as well as the appended drawings. Aspects of an invention are defined in the appended independent claims.

[0035] There is provided an organic light emitting display device including a substrate including a pixel region, a first electrode over the substrate and in the pixel region, an auxiliary electrode over the substrate and at a boundary of the pixel region, a second electrode over the first electrode and the auxiliary electrode, a conductive member between the auxiliary electrode and the second electrode and electrically connecting the second electrode to the auxiliary electrode, and an organic layer between each of the first electrode and the auxiliary electrode and the second electrode, wherein the organic layer is opened by the conductive member.

[0036] The organic layer may include a blue emitting layer.

[0037] The organic layer may further include at least one of the red emitting layer and a green emitting layer between the first and second electrodes.

[0038] The auxiliary electrode may extend along a boundary portion of the pixel region.

[0039] The organic light emitting display device may further include a bank disposed on edges of the first electrode and include an auxiliary contact hole exposing the auxiliary electrode.

[0040] The conductive member may be disposed in the auxiliary contact hole and may contact the auxiliary electrode in a portion where the organic layer is opened.

[0041] The conductive member may contact the auxiliary electrode and a side surface of the bank in the auxiliary contact hole.

[0042] There is further provided an organic light emitting display device including a substrate including a pixel region, a first electrode over the substrate and in the pixel region, an auxiliary electrode over the substrate and at a boundary of the pixel region, a bank on edges of the first electrode and including an auxiliary contact hole exposing the auxiliary electrode, an organic material pattern on the bank, an organic emitting layer on the first electrode, a conductive member in the auxiliary contact hole, and a second electrode on the conductive member and the organic layer, wherein the second electrode is electrically connected to the auxiliary electrode via the conductive member.

[0043] The organic material pattern may contact edges of the auxiliary electrode, and the conductive member may contact the center of the auxiliary electrode.

[0044] The conductive member may contact a side surface of the bank in the auxiliary contact hole and an upper surface of the auxiliary electrode.

[0045] The organic material pattern may have a thinner part on the auxiliary electrode, and the conductive member may be disposed on the thinner part of the organic material pattern.

[0046] There is also provided a method of fabricating an organic emitting display device. A first electrode and an auxiliary electrode is formed over a substrate including a pixel region, wherein the first electrode is disposed in the pixel region. The auxiliary electrode is disposed at a boundary of the pixel region, and a bank on edges of the first electrode and including an auxiliary contact hole exposing the auxiliary electrode is formed. An organic material pattern is formed on the bank and an organic emitting layer is formed on the first electrode. A conductive member is formed in the auxiliary contact hole and is electrically connected to the auxiliary electrode. A second electrode is formed on the conductive member and the organic layer.

[0047] The conductive member may be formed by dropping a metal paste into the auxiliary contact hole such that the organic material pattern in the auxiliary contact hole is dissolved, and drying the metal paste and the dissolved organic material pattern such that the conductive member directly or indirectly contacting the auxiliary electrode is formed.

[0048] The metal paste may include a conductive particle and a binder including a resin, a solvent and additives.

[0049] The organic material pattern and the organic emitting layer may be formed by forming a lower layer of the organic emitting layer by a solution process, and forming the organic material pattern and an upper layer of the organic emitting layer by a deposition process.

[0050] Embodiments also relate to an organic light emitting display device. The organic light emitting display device includes a substrate including a plurality of pixel regions, and a first electrode over the substrate and in a pixel region of the plurality of pixel regions. An auxiliary elec-

trode is over the substrate, and the auxiliary electrode is spaced apart from the first electrode and disposed in between the pixel region and another pixel region of the plurality of pixel regions. A second electrode is over the first electrode and the auxiliary electrode, and an organic layer is disposed between the first electrode and the second electrode, and is disposed between the second electrode and the auxiliary electrode. A conductive droplet is placed between the auxiliary electrode and the second electrode. The conductive droplet electrically connects the second electrode to the auxiliary electrode.

[0051] Embodiments also relate to a method of fabricating an organic emitting display device. A first electrode is formed on a substrate having a plurality of pixel regions. The first electrode is formed in a pixel region of the plurality of pixel regions. An auxiliary electrode is formed over the substrate, and the auxiliary electrode is spaced apart from the first electrode and disposed in between the pixel region and another pixel region of the plurality of pixel regions. An organic layer is formed over at least the first electrode and the auxiliary electrode. A conductive member is formed on the auxiliary electrode, and a second electrode is formed over the organic layer and the conductive member. The second electrode is electrically connected to the auxiliary electrode through the conductive member.

[0052] Embodiments also relate to an organic light emitting display device. The organic light emitting device includes a substrate having a plurality of first electrodes, and an auxiliary electrode disposed in between a first one of the first electrodes and a second one of the first electrodes. The auxiliary electrode is spaced apart from the first one of the first electrodes. An organic emitting layer disposed on the first one of the first electrodes, and a conductive member is disposed on the auxiliary electrode. A second electrode is disposed on the organic emitting layer and the conductive member, and the second electrode is electrically connected to the auxiliary electrode through the conductive member.

[0053] It is to be understood that both the foregoing general description and the following detailed description are by example and explanatory and are intended to provide further explanation of the claimed subject-matter.

BRIEF DESCRIPTION OF THE DRAWINGS

[0054] The accompanying drawings, which are included to provide a further understanding of the disclosure and are incorporated in and constitute a part of this specification, illustrate embodiments and together with the description serve to explain the principles of the disclosure.

[0055] FIG. 1 is a schematic plane view of the related art OLED device.

[0056] FIG. 2 is a schematic cross-sectional view taken along the line II-II in FIG. 1.

[0057] FIG. 3 is a schematic plane view of an OLED device according to an embodiment.

[0058] FIG. 4 is a schematic cross-sectional view taken along the line IV-IV in FIG. 3.

[0059] FIGS. 5A to 5F are schematic cross-sectional views illustrating a fabricating process of an OLED device according to an embodiment.

DETAILED DESCRIPTION OF EMBODIMENTS

[0060] Reference will now be made in detail to embodiments, examples of which are illustrated in the accompanying drawings.

[0061] In the related art OLED device, the blue emitting material pattern, the ETL and the EIL, which are formed by the deposition process, are formed on or over the auxiliary electrode **53** as well as the first electrode **50**. Accordingly, to electrically connect the second electrode **70** to the auxiliary electrode **53** through the auxiliary contact hole **55**, the above layers on or over the auxiliary electrode **53** in the auxiliary contact hole **55** should be removed during the manufacturing process.

[0062] The above layers are removed by irradiating a laser beam onto the layers in the auxiliary contact hole. However, since an expensive laser irradiating apparatus is required, the fabricating process is complicated and the production cost is increased.

[0063] FIG. 3 is a schematic plane view of an OLED device according to an embodiment, and FIG. 4 is a schematic cross-sectional view taken along the line IV-IV in FIG. 3.

[0064] Referring to FIG. 3, an OLED device according to an embodiment includes a substrate **101**, which includes a plurality of pixel regions P, a first electrode **150** disposed on or over the substrate **101** and in each pixel region P, an auxiliary electrode **153** disposed at a boundary of the pixel region P and a bank **157** disposed at the boundary of the pixel region P. The auxiliary electrode **153** is spaced apart from the first electrode **150** and may be disposed in between one or more pairs of pixel regions P, or in between pixel regions P and an edge of the substrate **101**. The bank **157** is disposed in between the first electrode **150** and the auxiliary electrode **153**, and covers an edge of the auxiliary electrode **153** and an edge of the first electrode **150** adjacent to the edge of the auxiliary electrode **153**. The bank **157** includes an auxiliary contact hole **155** exposing a portion of the auxiliary electrode **153**.

[0065] The auxiliary electrode **153** and the auxiliary contact hole **155** extend along the substrate **101** in a direction between one or more pairs of adjacent pixel regions P.

[0066] Referring to FIG. 4, a semiconductor layer **113** including a first region **113a** and second regions **113b** at both sides of the first region **113a** is formed on the substrate **101**. The first region **113a** is formed of intrinsic poly-silicon, and the second region **113b** is formed of impurity-doped poly-silicon.

[0067] A gate insulating layer **115** is formed on the semiconductor layer **113**, and a gate electrode **125** corresponding to the first region **113a** of the semiconductor layer **113** is formed on the gate insulating layer **115**. An interlayer insulating layer **117** is formed on the gate electrode **125**.

[0068] In this instance, semiconductor contact holes **121** are formed through the gate insulating layer **115** and the interlayer insulating layer **117** to expose the second regions **113b** of the semiconductor layer **113**.

[0069] A source electrode **133** and a drain electrode **136**, which are spaced apart from each other, are formed on the interlayer insulating layer **117**. The source and drain electrodes **133** and **136** are electrically connected to the second regions **113b** of the semiconductor layer **113** through the semiconductor contact holes **121**, respectively.

[0070] The semiconductor layer **113**, the gate electrode **125**, the source electrode **133** and the drain electrode **136** constitute a driving TFT DTr.

[0071] A passivation layer **119**, which may provide a flat top surface, is formed on or over the driving TFT DTr and over an entire surface of the substrate **101**. A drain contact

hole **143** exposing the drain electrode **136** of the driving TFT DTr is formed through the passivation layer **119**.

[0072] The first electrode **150**, which is connected to the drain electrode **136** through the drain contact hole **143**, is formed on the passivation layer **119** and in the pixel region P, and the auxiliary electrode **153**, which is spaced apart from the first electrode **150**, is formed on the passivation layer **119** and at the boundary of the pixel region P in between one or more pairs of adjacent pixel regions P. The first electrode **150** may also be formed in between pixel regions P and an edge of the substrate **101**.

[0073] The bank **157**, which includes the auxiliary contact hole **155** exposing the auxiliary electrode **153**, covers an edge of the first electrode **150** and an edge of the auxiliary electrode **153** adjacent to the edge of the first electrode **150**, and is formed at the boundary of the pixel region P in between the first electrode **150** and the auxiliary electrode **153**. The bank **157** has a lattice shape to surround the pixel region P.

[0074] An organic emitting layer **160b** is disposed on the first electrode **150**. An organic material pattern **160a** is disposed on an upper surface of the bank **157** and side surfaces of the bank **157** in the auxiliary contact hole **155**, as well as on the portion of the auxiliary electrode **153** exposed through the auxiliary contact hole **155**. For example, the organic material pattern **160a** may cover side surfaces of the bank **157** in the auxiliary contact hole **155** and may expose at least a portion of the auxiliary electrode **153** in the auxiliary contact hole **155**. Alternatively, the organic material pattern **160a** may expose an entire surface of the auxiliary electrode **153** in the auxiliary contact hole **155**.

[0075] The organic material pattern **160a** may be in the same layer as one or more layers of the organic emitting layer **160b**. For example, the organic material pattern **160a** may extend from one or more layers of the organic emitting layer **160b** to extend over the bank **157**, and cover side surfaces of the bank **157** partially or completely. As another example, the organic material pattern **160a** may entirely cover the bank **157** and the auxiliary electrode **153** exposed by the bank **157**. Alternatively, the organic material pattern **160a** may be spaced apart from the organic emitting layer **160b**.

[0076] A conductive member **165** contacting the organic material pattern **160a** and the exposed portion of the auxiliary electrode **153** is disposed in the auxiliary contact hole **155**. In one embodiment, the conductive member **165** is a conductive droplet in which at least a portion of the conductive member **165** has round curvature. For example, the conductive member **165** may be shaped as a conductive ball, a conductive elongated sphere, a conductive ellipsoid, or a hemi-spherical shape.

[0077] In addition, a second electrode **170** is disposed over an entire surface of the substrate **101**. Namely, the second electrode **170** contacts the organic emitting layer **160b** on the first electrode **150** and the conductive member **165** in the auxiliary contact hole **155**.

[0078] The first and second electrodes **150** and **170** and the organic emitting layer **160b** therebetween constitute an organic emitting diode E.

[0079] The second electrode **170** is electrically connected to the auxiliary electrode **153** via the conductive member **165**. As a result, the resistance or sheet resistance of the second electrode **170** is reduced due to the auxiliary elec-

trode **153** such that the brightness non-uniformity problem can be prevented or minimized.

[0080] The organic emitting layer **160b** on the first electrode **150** may include a hole injection layer (HIL), a hole transport layer (HTL), an emission layer (EML), an electron transport layer (ETL), and an electron injection layer (EIL) sequentially stacked on the first electrode **150**. Some of the layers of the organic emitting layer **160b** may be formed by a solution process, and the rest of the layers of the organic material layer **160b** may be formed by a deposition process. The organic material pattern **160a** may be in the same layer as one or more layers of the organic emitting layer **160b** formed through a deposition process.

[0081] As mentioned above, because of the stability of the material and the emitting property in the layer formed by the solution process, each of the HIL, the HTL, the red emitting material pattern and the green emitting material pattern may be formed in each pixel region P by the solution process, while each of the blue emitting material pattern, the ETL and the EIL may be formed over an entire surface of the substrate **101** by the deposition process.

[0082] In this instance, the organic material pattern **160a** in the auxiliary contact hole **155** and on the auxiliary electrode **153** includes material patterns formed by the deposition process. For example, the organic material pattern **160a** may include an electron transport material pattern and an electron injection material pattern. Alternatively, the organic material pattern **160a** may include a blue emitting material pattern, an electron transport material pattern and an electron injection material pattern.

[0083] On the other hand, when all layers of the organic emitting layer **160b** are formed by the deposition process, the organic material pattern **160a** may include similar structure as the organic emitting layer **160b**, e.g., a hole injection material pattern, a hole transport material pattern, an electron transport material pattern, and an electron injection material pattern.

[0084] Since the material layers, which are deposited, are formed on the auxiliary electrode **153** as well as the first electrode **150**, the material layers on the auxiliary electrode **153** should be removed for an electrical connection between the second electrode **170** and the auxiliary electrode **153**.

[0085] In one embodiment, at least a portion of the organic material pattern **160a** on the auxiliary electrode **153** is removed to expose at least a portion of the auxiliary electrode **153**, and the conductive member **165** is formed on the exposed portion of the auxiliary electrode **153**. In other words, at least a portion of the auxiliary electrode **153** is exposed through an opening in the organic material pattern **160a** in which the conductive member **165** contacts the auxiliary electrode **153**. In addition, the second electrode **170** is formed on the conductive member **165** such that the second electrode **170** and the auxiliary electrode **153** are electrically connected to each other via the conductive member **165**.

[0086] The conductive member **165** may be a conductive droplet, a conductive ball, or a conductive elongated sphere. The conductive member **165** may be formed by dropping and drying a metal paste **163** (of FIG. 5D) on the organic material pattern **160a** in the auxiliary contact hole **155**. The metal paste **163** may include a conductive particle, e.g., silver (Ag), aluminum (Al), nickel (Ni) or gold (Au), and a binder. The binder may include a resin, a solvent, and other additives.

[0087] In this instance, at least a portion of the organic material pattern 160a on the auxiliary electrode 153 is dissolved into the solvent in the metal paste 163 (of FIG. 5D) such that the conductive member 165 contacts the auxiliary electrode 153 in the auxiliary contact hole 155 after the drying step. Accordingly, the organic material pattern 160a is formed on side surfaces of the bank 157 in the auxiliary contact hole 155 and at least a portion of the auxiliary electrode 153 is exposed such that the conductive member 165 contacts the auxiliary electrode 153.

[0088] In other words, the organic layer including the organic material pattern 160a and the organic emitting layer 160b may cover an entire surface of the substrate 101 except a portion in which the conductive member 165 contacts the auxiliary electrode 153. Namely, the conductive member 165 may create an opening in the organic layer in which the conductive member 165 can contact the auxiliary electrode 153.

[0089] Alternatively, the organic material pattern 160a on the auxiliary electrode 153 and a portion of the organic material pattern 160a on the side surfaces of the bank 157 may be removed such that the organic material pattern 160a partially covers side surfaces of the bank 157. Alternatively, the organic material pattern 160a on the auxiliary electrode 153 and the side surface of the bank 157 in the auxiliary contact hole 155 may be completely removed such that the conductive member 165 may contact the side surface of the bank 157 as well as the auxiliary electrode 153.

[0090] On the other hand, the materials on the auxiliary electrode 153 may be partially dissolved by the solvent in the metal paste. In this instance, the organic material pattern 160a may cover the auxiliary electrode 153, and only a center portion of the auxiliary electrode 153 may be exposed. Alternatively, the organic material pattern 160a may cover an entire surface of the auxiliary electrode 153 in the auxiliary contact hole 155 with smaller thickness. Namely, a portion of the organic material pattern 160a on the auxiliary electrode 153 may be thinner than a portion of the organic material pattern 160a on the side surface and/or the upper surface of the bank 157. In this instance, the organic material pattern 160a may have a "U" shape in a cross-sectional view at the auxiliary contact hole 155.

[0091] The organic material pattern 160a may extend from one or more layers of the organic emitting layer 160b to extend over the bank 157 and cover an entire surface of the auxiliary electrode 153 exposed by the bank 157. Due to the metal paste, the portion of the organic material pattern 160a contacting the auxiliary electrode 153 may have a smaller thickness than portions of the organic material pattern 160a contacting the bank 157.

[0092] Even when the auxiliary electrode 153 partially contacts the conductive member 165 or indirectly contacts the conductive member 165 with the thinner part of the organic material pattern 160a, the electrical connection between the second electrode 170 and the auxiliary electrode 153 via the conductive member 165 can be secured.

[0093] Namely, an end of the conductive member 165 is electrically connected to the auxiliary electrode 153 and the other end of the conductive member 165 is electrically connected to the second electrode 170 such that the second electrode 170 is electrically connected to the auxiliary electrode 153.

[0094] In the OLED device of the present disclosure, since the organic materials on the auxiliary electrode 153 in the

auxiliary contact hole 155 are removed without the expensive laser irradiating apparatus, the fabricating process is simplified and the production cost is reduced. In addition, since the second electrode 170 is electrically connected to the auxiliary electrode 153 via the conductive member 165, the sheet resistance of the second electrode 170 is decreased. Moreover, since the step difference of the second electrode 170 in the auxiliary contact hole 155 is decreased due to the conductive member 165, the disconnection problem of the second electrode 170 in the step of the auxiliary contact hole is prevented. The conductive member 165 may fill the auxiliary contact hole 155 to provide a flat top surface with an upper surface of the organic material pattern 160a on the top surface of the bank 157. In this instance, the second electrode 170 may have a flat top surface over the bank 157 and the auxiliary electrode 153.

[0095] The auxiliary electrode 153 and the auxiliary contact hole 155 extend along a direction one or more pairs of adjacent pixel regions P. As a result, the auxiliary contact hole 155 may be referred to as a groove.

[0096] In FIG. 3, the auxiliary electrode 153 and the auxiliary contact hole 155 horizontally extend along the substrate 101 in between one or more pairs of pixel regions P. Alternatively, the auxiliary electrode 153 and the auxiliary contact hole 155 may extend in a vertical direction along the substrate 101. Alternatively, the auxiliary electrode 153 and the auxiliary contact hole 155 may extend in a horizontal direction and a vertical direction such that the auxiliary electrode 153 and the auxiliary contact hole 155 have a lattice shape.

[0097] Since the auxiliary electrode 153 and the auxiliary contact hole 155 extend along at least one of the horizontal and vertical directions, an area for dropping the metal paste is increased. Accordingly, a size margin of the conductive particle of the conductive member 165 and an aligning margin of the dropping process of the metal paste are increased such that the electrical connection between the second electrode 170 and the auxiliary electrode 153 is secured.

[0098] FIGS. 5A to 5F are schematic cross-sectional views illustrating a fabricating process of an OLED device according to an embodiment.

[0099] A method of fabricating the OLED device according to the present disclosure includes forming a first electrode 150 and an auxiliary electrode 153, forming a bank 157, forming an organic material pattern 160a and an organic emitting layer 160b, removing a portion of the organic material pattern 160a and forming a conductive member 165, and forming a second electrode 170.

[0100] As shown in FIG. 5A, the first electrode 150 and the auxiliary electrode 153 are formed over the substrate 101, where elements, e.g., the driving TFT DTr, the passivation layer 119, and so on are formed. The first electrode 150 is disposed in the pixel region P and is electrically connected to the drain electrode 136 of the driving TFT DTr through the drain contact hole 143. The auxiliary electrode 153 is disposed between a pair of pixel regions P and is spaced apart from the first electrode 150. Each of the first electrode 150 and the auxiliary electrode 153 may be formed of the same material. For example, each of the first electrode 150 and the auxiliary electrode 153 may be formed of a transparent conductive material, e.g., indium-tin-oxide (ITO) and indium-zinc-oxide (IZO).

[0101] Next, as shown in FIG. 5B, an insulating material layer (not shown) is formed and patterned to form the bank 157. The bank 157 includes the auxiliary contact hole 155 and an opening. The auxiliary electrode 153 is exposed through the auxiliary contact hole 155, and the first electrode 150 is exposed through the opening. Namely, the bank 157 covers edges of the auxiliary electrode 153 and the first electrode 150.

[0102] Next, as shown in FIG. 5C, the organic material pattern 160a and the organic emitting layer 160b are formed over the substrate 101 including the bank 157. The organic material pattern 160a is formed on the auxiliary electrode 153 in the auxiliary contact hole 155 and the upper and side surfaces of the bank 153. The organic emitting layer 160b is formed on the first electrode 150. The organic material pattern 160a may be in the same layer as one or more layers of the organic emitting layer 160b, and extend from the one or more layers of the organic emitting layer 160b.

[0103] As mentioned above, the organic emitting layer 160b may include the HIL, the HTL, the EML, the ETL and the EIL sequentially stacked on the first electrode 150. Some of the layers of the organic emitting layer 160b may be formed of the deposition process, or all of the layers of the organic emitting layer 160a may be formed of the deposition process.

[0104] Because of the stability of the material and the emitting property in the layer formed by the solution process, each of the HIL, the HTL, the red emitting material pattern and the green emitting material pattern may be formed in each pixel region P by the solution process, while each of the blue emitting material pattern, the ETL and the EIL may be formed over an entire surface of the substrate 101 by the deposition process. This process may be referred to as a solution fabricating process.

[0105] In the solution fabricating process, the layers by the deposition process are formed between the pixel regions P as well as within the pixel region P. Namely, the organic material pattern 160a may have a double-layered structure of an electron transport material pattern and an electron injection material pattern or a triple-layered structure of a blue emitting material pattern, the electron transport material pattern and the electron injection material pattern. Alternatively, in the deposition fabricating process, the organic material pattern 160a may have a structure of a hole injection material pattern, a hole transport material pattern, the electron transport material pattern and the electron injection material pattern.

[0106] Next, as shown in FIG. 5D, a metal paste 163 is dropped into the auxiliary contact hole 155 using a dispenser 180 such that at least a portion of the organic material pattern 160a on the auxiliary electrode 153 is dissolved. In this instance, the organic material pattern 160a on the auxiliary electrode 153 may be completely or partially dissolved. In addition, the organic material pattern 160a on the side surface of the bank 157 in the auxiliary contact hole 155 may be partially or completely dissolved.

[0107] The metal paste 163 and the dissolved organic material of the organic material pattern 160a are dried such that the remaining conductive member 165 is formed in the auxiliary contact hole 155 as shown in FIG. 5E. In one embodiment, the conductive member 165 is a conductive droplet in which at least a portion of the conductive member 165 has round curvature. For example, the conductive

member 165 may be shaped as a conductive ball, a conductive elongated sphere, a conductive ellipsoid, or a hemispherical shape.

[0108] In FIG. 5E, an end of the conductive member 165 contacts a center of the auxiliary electrode 153. Alternatively, the conductive member 165 may contact an entire upper surface of the auxiliary electrode 153 in the auxiliary contact hole 155. In addition, the conductive member 165 may indirectly contact the auxiliary electrode 153 with a thin organic material pattern 160a therebetween. Moreover, the conductive member 165 may contact the side surface of the bank 157 in the auxiliary contact hole 155.

[0109] The conductive member 165 may be a conductive droplet, a conductive ball, or a conductive elongated sphere. The conductive member 165 may be formed by dropping and drying a metal paste 163, which includes a conductive particle, e.g., silver (Ag), aluminum (Al), nickel (Ni) or gold (Au), and a binder, on the organic material pattern 160a in the auxiliary contact hole 155. The binder may include a resin, a solvent and additives.

[0110] The materials on the auxiliary electrode 153 are dissolved into the solvent in the metal paste 163 and the materials and the solvent are removed by the drying step such that the conductive member 165 contacts the auxiliary electrode 153 in the auxiliary contact hole 155 after the drying step. Accordingly, the organic material pattern 160a is formed on side surfaces of the bank 157 in the auxiliary contact hole 155 and at least a portion of the auxiliary electrode 153 is exposed in which the conductive member 165 contacts the auxiliary electrode 153.

[0111] The organic material pattern 160a may also extend from one or more layers of the organic emitting layer 160b along the bank 157 to at least partially cover a side surface of the bank 157 contacting the auxiliary electrode 153. The organic material pattern 160a may also entirely cover the bank 157 and the auxiliary electrode 153 exposed by the bank 157, such that a thickness of a portion of the organic material pattern 160a contacting the auxiliary electrode 153 is smaller than a thickness of a portion of the organic material pattern 160a contacting the bank 157. The organic material pattern 160a may also cover the auxiliary electrode 153, such that at least a portion of the auxiliary electrode 153 is exposed through an opening in the organic material pattern 160a in which the conductive member 165 contacts the auxiliary electrode 153.

[0112] Next, as shown in FIG. 5F, the second electrode 170 is formed on the organic emitting layer 160b, the conductive member 165 and the organic material pattern 160a on an upper surface of the bank 157. The second electrode 170 is formed over an entire surface of the substrate 101, and the first and second electrodes 150 and 170 and the organic emitting layer 160b constitutes the organic emitting diode E.

[0113] The second electrode 170 contacts the conductive member 165 such that the second electrode 170 and the auxiliary electrode 153 are electrically connected to each other via the conductive member 165.

[0114] In the OLED device of the present disclosure, since the organic materials on the auxiliary electrode 153 in the auxiliary contact hole 155 are removed without the expensive laser irradiating apparatus, the fabricating process is simplified and the production cost is reduced. In addition, since the second electrode 170 is electrically connected to the auxiliary electrode 153 via the conductive member 165,

the sheet resistance of the second electrode **170** is decreased. Moreover, since the step difference of the second electrode **170** in the auxiliary contact hole **155** is decreased due to the conductive member **165**, the disconnection problem of the second electrode **170** in the step of the auxiliary contact hole is prevented.

[0115] It will be apparent to those skilled in the art that various modifications and variations can be made to the embodiments without departing from the scope of the appended claims. Thus, it is intended that the embodiments are not limiting and modifications and variations are covered provided they come within the scope of the appended claims and their equivalents.

What is claimed is:

1. An organic light emitting display device, comprising:
a substrate including a plurality of pixel regions;
a first electrode over the substrate and in a pixel region of the plurality of pixel regions;
an auxiliary electrode over the substrate, the auxiliary electrode spaced apart from the first electrode and disposed in between the pixel region and another pixel region of the plurality of pixel regions;
a second electrode over the first electrode and the auxiliary electrode;
an organic layer disposed between the first electrode and the second electrode, and disposed between the second electrode and the auxiliary electrode; and
a conductive droplet between the auxiliary electrode and the second electrode and electrically connecting the second electrode to the auxiliary electrode.
2. The organic light emitting display device of claim 1, wherein the organic layer includes a blue light emitting layer.
3. The organic light emitting display device of claim 1, wherein the organic layer further includes at least one of a red light emitting layer and a green light emitting layer between the first electrode and the second electrode.
4. The organic light emitting display device of claim 1, wherein the auxiliary electrode extends along the substrate in between one or more pairs of pixel regions including the pixel region and the other pixel region.
5. The organic light emitting display device of claim 1, further comprising a bank covering an edge of the first electrode and an edge of the auxiliary electrode adjacent to the edge of the first electrode, wherein the auxiliary electrode is exposed through an auxiliary contact hole in the bank.
6. The organic light emitting display device of claim 5, wherein the organic layer is disposed on the auxiliary electrode, and wherein the conductive droplet is disposed in the auxiliary contact hole and contacts the auxiliary electrode through an opening in the organic layer.
7. The organic light emitting display device of claim 5, wherein the conductive droplet contacts the auxiliary electrode, and a side surface of the bank contacting the auxiliary electrode.
8. The organic light emitting display device of claim 5, wherein the organic layer is further disposed over the bank, and the organic layer includes an organic emitting portion disposed over the first electrode, and an organic material pattern portion disposed over the bank and the auxiliary electrode, wherein the organic material pattern portion is in the same layer as one or more layers of the organic emitting portion.

9. The organic light emitting display device of claim 8, wherein the organic material pattern portion contacts edges of the auxiliary electrode, and the conductive droplet contacts a center of the auxiliary electrode.

10. The organic light emitting display device of claim 8, wherein the organic material pattern portion is between the conductive droplet and the auxiliary electrode.

11. A method of fabricating an organic emitting display device, comprising:

- forming a first electrode on a substrate having a plurality of pixel regions, the first electrode formed in a pixel region of the plurality of pixel regions;
- forming an auxiliary electrode over the substrate, the auxiliary electrode spaced apart from the first electrode and disposed in between the pixel region and another pixel region of the plurality of pixel regions;
- forming an organic layer over at least the first electrode and the auxiliary electrode;
- forming a conductive member on the auxiliary electrode; and
- forming a second electrode over the organic layer and the conductive member, the second electrode electrically connected to the auxiliary electrode through the conductive member.

12. The method of claim 11, further comprising forming a bank over an edge of the first electrode and an edge of the auxiliary electrode adjacent to the edge of the first electrode before forming the organic layer, the auxiliary electrode exposed through an auxiliary contact hole in the bank.

13. The method of claim 12, wherein forming the organic layer over the first electrode and the auxiliary electrode comprises:

- forming an organic emitting portion of the organic layer over the first electrode; and
- forming an organic material pattern portion of the organic layer over the bank and in the auxiliary contact hole over the auxiliary electrode, the organic material pattern portion formed in a same layer as one or more layers of the organic emitting portion.

14. The method of claim 13, wherein forming the conductive member comprises:

- dropping a metal paste into the auxiliary contact hole such that at least a part of the organic material pattern portion in the auxiliary contact hole is dissolved by the metal paste; and
- drying the metal paste and the dissolved part of the organic material pattern portion to form the conductive member, wherein the conductive member is electrically connected to the auxiliary electrode.

15. The method of claim 14, wherein the metal paste comprises a conductive particle and a solvent capable of dissolving the organic material pattern.

16. The method according to claim 13, wherein forming the organic material pattern portion and the organic emitting portion comprises:

- forming the one or more layers of the organic emitting portion by a solution process; and
- forming the organic material pattern portion and the corresponding one or more layers of the organic emitting portion in the same layer as the organic material pattern portion by a deposition process.

17. The method of claim 12, wherein forming the conductive member on the auxiliary electrode comprises form-

ing the conductive member in the auxiliary contact hole such that the conductive member is electrically connected to the auxiliary electrode.

18. An organic light emitting display device, comprising:
a substrate having a plurality of first electrodes;
an auxiliary electrode disposed in between a first one of the first electrodes and a second one of the first electrodes, where the auxiliary electrode is spaced apart from the first one of the first electrodes;
an organic emitting layer disposed on the first one of the first electrodes;
a conductive member disposed on the auxiliary electrode; and
a second electrode disposed on the organic emitting layer and the conductive member, the second electrode electrically connected to the auxiliary electrode through the conductive member.

19. The organic light emitting display device of claim **18**, further comprising a bank between the first electrode and the

auxiliary electrode covering edges of the auxiliary electrode and the first one of the first electrodes adjacent to the auxiliary electrode.

20. The organic light emitting display device of claim **19**, further comprising an organic material pattern that extends from one or more layers of the organic emitting layer along the bank to at least partially cover a side surface of the bank contacting the auxiliary electrode.

21. The organic light emitting display device of claim **20**, wherein the organic material pattern covers the bank and the auxiliary electrode exposed by the bank, a thickness of a portion of the organic material pattern contacting the auxiliary electrode being smaller than a thickness of a portion of the organic material pattern contacting the bank.

22. The organic light emitting display device of claim **18**, further comprising an organic material pattern covering the auxiliary electrode, wherein at least a portion of the auxiliary electrode is exposed through an opening in the organic material pattern in which the conductive member contacts the auxiliary electrode.

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专利名称(译)	有机发光显示装置及其制造方法		
公开(公告)号	US20170125725A1	公开(公告)日	2017-05-04
申请号	US15/334997	申请日	2016-10-26
[标]申请(专利权)人(译)	乐金显示有限公司		
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IPC分类号	H01L51/52 H01L51/00 H01L51/56 H01L51/50 H01L27/32		
CPC分类号	H01L51/5212 H01L51/504 H01L51/5228 H01L2227/323 H01L51/56 H01L51/0021 H01L51/0003 H01L27/3246 H01L27/3244 H01L51/5203 H01L27/3279 H01L51/0022		
优先权	1020150154133 2015-11-03 KR		
其他公开文献	US10686156		
外部链接	Espacenet USPTO		

摘要(译)

一种有机发光显示装置，包括：基板，包括像素区域;以及位于所述基板上方和所述像素区域中的第一电极。辅助电极设置在基板上方，并且与第一电极间隔开并且设置在像素区域和另一像素区域之间。第二电极放置在第一电极和辅助电极上，并且有机层设置在第一电极和第二电极中的每一个与第二电极和辅助电极之间。导电构件放置在辅助电极和第二电极之间，并将第二电极电连接到辅助电极。

